# **ESD11N5.0ST5G**

# Transient Voltage **Suppressors**

# Micro-Packaged Diodes for ESD Protection

The ESD11N is designed to protect voltage sensitive components that require ultra-low capacitance from ESD and transient voltage events. Excellent clamping capability, low capacitance, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed and antenna line applications.

#### **Specification Features**

- Low Capacitance 0.6 pF
- Low Clamping Voltage
- Small Body Outline Dimensions: 0.60 mm x 0.30 mm
- Low Body Height: 0.3 mm
- Stand-off Voltage: 5.0 V
- Low Leakage
- Response Time is < 1 ns
- IEC61000-4-2 Level 4 ESD Protection
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

**Mechanical Characteristics MOUNTING POSITION:** Any

**QUALIFIED MAX REFLOW TEMPERATURE: 260°C** 

Device Meets MSL 1 Requirements

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Contact Air		±8.0 ±15	kV
Total Power Dissipation on FR-5 Board (Note 1) @ T <sub>A</sub> = 25°C Thermal Resistance, Junction-to-Ambient	P <sub>D</sub> R <sub>θJA</sub>	250 400	mW °C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-40 to +125	°C
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1.  $FR-5 = 1.0 \times 0.75 \times 0.62$  in.



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DSN<sub>2</sub> CASE 152AA

# **MARKING DIAGRAM**

PIN 1



XXXX = Specific Device Code YYY = Year Code

# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
ESD11N5.0ST5G	DSN2 (Pb-Free)	5000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

See Application Note AND8308/D for further description of survivability specs.

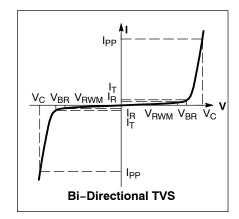
## **ESD11N5.0ST5G**

## **ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
I <sub>T</sub>	Test Current

<sup>\*</sup>See Application Note AND8308/D for detailed explanations of datasheet parameters.



# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

		V <sub>RWM</sub> (V)	I <sub>R</sub> (μΑ) @ V <sub>RWM</sub>	V <sub>BR</sub> (V) @ I <sub>T</sub> (Note 2)	Ιτ	C (	pF)	Vc
Device	Device Marking	Max	Max	Min	mA	Тур	Max	Per IEC61000-4-2 (Note 3)
ESD11N5.0ST5G	N5S0	5.0	1.0	5.8	1.0	0.6	0.9	Figures 1 and 2 See Below

- V<sub>BR</sub> is measured with a pulse test current I<sub>T</sub> at an ambient temperature of 25°C.
   For test procedure see Figures 3 and 4 and Application Note AND8307/D.

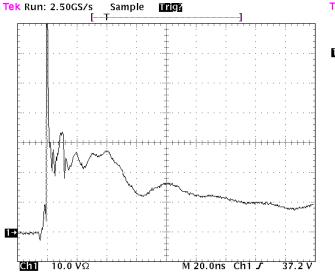


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV Contact per IEC61000-4-2

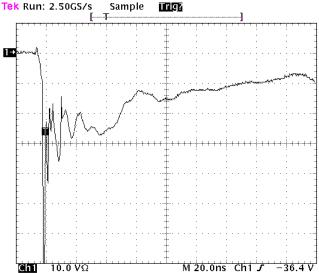


Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2

#### IEC 61000-4-2 Spec.

	_			
Level	Test Voltage (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8

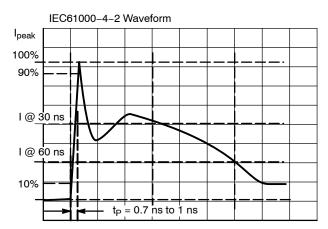


Figure 3. IEC61000-4-2 Spec

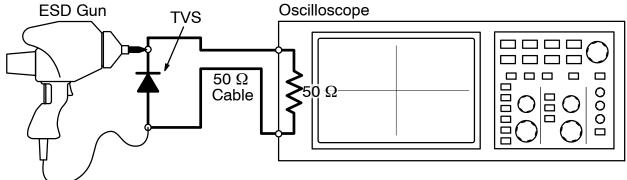


Figure 4. Diagram of ESD Test Setup

The following is taken from Application Note AND8308/D – Interpretation of Datasheet Parameters for ESD Devices.

# **ESD Voltage Clamping**

For sensitive circuit elements it is important to limit the voltage that an IC will be exposed to during an ESD event to as low a voltage as possible. The ESD clamping voltage is the voltage drop across the ESD protection diode during an ESD event per the IEC61000-4-2 waveform. Since the IEC61000-4-2 was written as a pass/fail spec for larger

systems such as cell phones or laptop computers it is not clearly defined in the spec how to specify a clamping voltage at the device level. ON Semiconductor has developed a way to examine the entire voltage waveform across the ESD protection diode over the time domain of an ESD pulse in the form of an oscilloscope screenshot, which can be found on the datasheets for all ESD protection diodes. For more information on how ON Semiconductor creates these screenshots and how to interpret them please refer to AND8307/D.

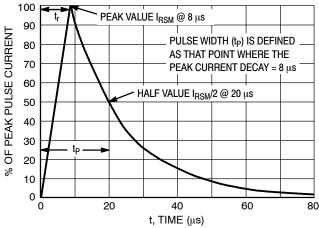
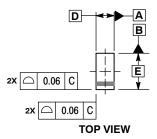


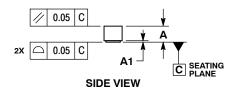
Figure 5. 8 X 20 µs Pulse Waveform

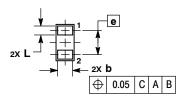
#### ESD11N5.0ST5G

#### PACKAGE DIMENSIONS

DSN2, 0.6x0.3, 0.4P, (0201) CASE 152AA-01 **ISSUE O** 

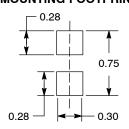






**BOTTOM VIEW** 

## **MOUNTING FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

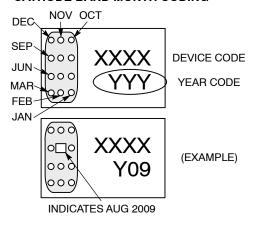
See Application Note AND8398/D for more mounting details

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
- 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.24	0.30	
A1	0.00	0.01	
b	0.22	0.28	
D	0.30 BSC		
Е	0.60 BSC		
е	0.40 BSC		
L	0.12	0.18	

#### **CATHODE BAND MONTH CODING**



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